# **Special Issue**

# Nanomaterials and Flexible Electronic Devices: Processing, Diagnostics and Applications

## Message from the Guest Editors

This Special Issue highlights the latest research and technological innovations in the fields of nanomaterials and flexible electronic devices, addressing their processing, diagnostic techniques, and cutting-edge applications. With rapid advancements in wearable electronics, artificial skin, and smart healthcare systems, flexible electronics have emerged as a transformative technology with a vast market potential. This Special Issue aims to gather high-quality contributions that explore novel materials, advanced fabrication methods, and emerging applications to overcome current limitations in flexibility, durability, and performance.

#### **Guest Editors**

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Dr. Ming Xiao

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### Deadline for manuscript submissions

30 November 2025



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mdpi.com/si/236807

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